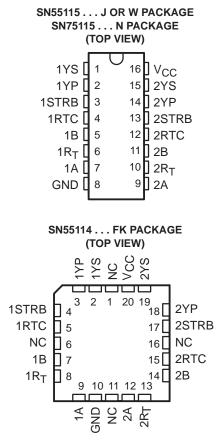
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- Choice of Open-Collector or Active Pullup (Totem-Pole) Outputs
- Single 5-V Supply
- Differential Line Operation
- Dual-Channel Operation
- TTL Compatible
- ±15-V Common-Mode Input Voltage Range
- Optional-Use Built-In 130-Ω Line-Terminating Resistor
- Individual Frequency-Response Controls
- Individual Channel Strobes
- Designed for Use With SN55113, SN75113, SN55114, and SN75114 Drivers
- Designed to Be Interchangeable With National DS9615 Line Receivers

description

The SN55115 and SN75115 dual differential line receivers are designed to sense small differential signals in the presence of large common-mode noise. These devices give TTL-compatible output signals as a function of the differential input voltage. The open-collector output configuration permits the wire-ANDing of similar TTL outputs (such as SN5401/SN7401) or other SN55115/SN75115 line receivers. This permits a level of logic to be implemented without extra delay.



NC - No internal connection

The output stages are similar to TTL totem-pole outputs, but with sink outputs, 1YS and 2YS, and the corresponding active pullup terminals, 1YP and 2YP, available on adjacent package pins. The frequency response and noise immunity may be provided by a single external capacitor. A strobe input is provided for each channel. With the strobe in the low level, the receiver is disabled and the outputs are forced to a high level.

The SN55115 is characterized for operation over the full military temperature range of -55° C to 125° C. The SN75115 is characterized for operation from 0°C to 70°C.

 FUNCTION TABLE											
STRB	DIFF INPUT (A AND B)	OUTPUT (YP AND YS TIED TOGETHER)									
L	Х	Н									
Н	L	Н									
Н	Н	L									

$$\begin{split} H = V_I \geq V_{IH} \mbox{ min or } V_{ID} \mbox{ more positive than } V_{T+} \mbox{ max} \\ L = V_I \leq V_{IL} \mbox{ max or } V_{ID} \mbox{ more negative than } V_{T-} \mbox{ max} \\ X = \mbox{ irrelevant} \end{split}$$



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

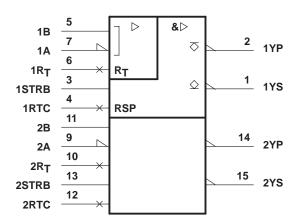
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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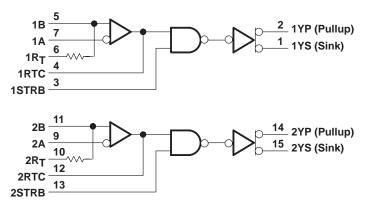
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logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

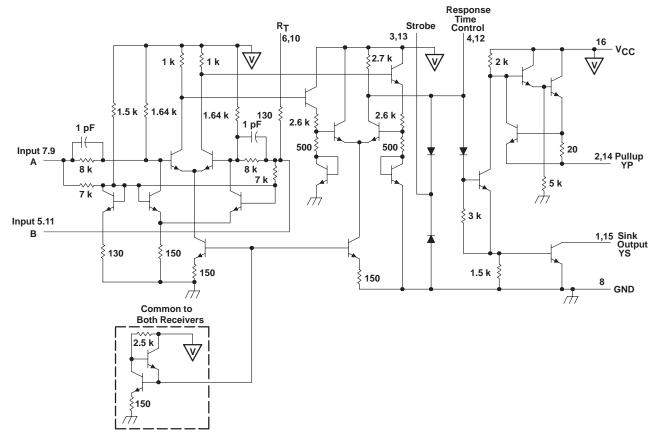
logic diagram (positive logic)





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schematic (each receiver)



Resistor values are nominal and in ohms. Pin numbers shown are for the J, N, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC} (see Note 1)	
Input voltage V _I (A, B, and R _T)	±25 V
Input voltage V _I (STRB)	5.5 V
Off-state voltage applied to open-collector outputs	14 V
Continuous total power dissipation	See Dissipation Rating Table
Storage temperature range, T _{stg}	–65°C to 150°C
Case temperature for 60 seconds: FK package	260°C
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds: J or W package	ge 300°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: N package	260°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values, except differential input voltage, are with respect to network ground terminal.



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DISSIPATION RATING TABLE											
PACKAGE	T _A ≤ 25°C POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING	T _A = 125°C POWER RATING							
FK†	1375 mW	11.0 mW/°C	880 mW	275 mW							
Jţ	1375 mW	11.0 mW/°C	880 mW	275 mW							
N	1150 mW	9.2 mW/°C	736 mW	—							
w†	1000 mW	8.0 mW/°C	640 mW	200 mW							

[†] In the FK, J, and W packages, SN55115 chips are either silver glass or alloy mounted. SN75115 chips are glass mounted.

recommended operating conditions

	5	SN55115		SN75115			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level input voltage at STRB, VIH	2.4			2.4			V
Low-level input voltage at STRB, VIL			0.4			0.4	V
High-level output current, IOH			-5			-5	mA
Low-level output current, IOL			15			15	mA
Operating free-air temperature, T _A	-55		125	0		70	°C



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	DADAMETED	TEO		5	SN55115		5	SN75115		UNIT	
	PARAMETER	TES	r conditions		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	UNII
v _{IT+} §	Positive-going threshold voltage	V _O = 0 .4 V,	I _{OL} = 15 mA,	$V_{IC} = 0$			500			500	mV
v _{IT−} §	Negative-going threshold voltage	V _O = 2 .4 V,	I _{OH} = -5 mA,	$V_{IC} = 0$	-500¶			-500¶			mV
VICR	Common-mode input voltage range	$V_{ID} = \pm 1 V$			+15 to -15	+24 to -19		+ 15 to - 15	+24 to -19		V
				T _A = MIN	2.2			2.4			
VOH	High-level ouput voltage	$V_{CC} = MIN,$ $I_{OH} = -5 mA$	$V_{ID} = -0.5 V$,	T _A = 25°C	2.4	3.4		2.4	3.4		V
			$T_A = MAX$	2.4			2.4				
V _{OL}	Low-level output voltage	$V_{CC} = MIN,$ $I_{OL} = 15 mA$	$V_{ID} = -0.5 V,$			0.22	0.4		0.22	0.45	V
				T _A = MIN			-0.9			-0.9	
IIL Low-level ir current	Low-level input	V _{CC} = MAX, Other input at 5.5	$V_{I} = 0.4 V,$	T _A = 25°C		-0.5	-0.7		-0.5	-0.7	mA
	current		J V	T _A = MAX			-0.7			-0.7	
lau	High-level strobe	V _{CC} = MIN,	V _{ID} = -0.5 V,	T _A = 25°C			2			5	A
ISH	current	V _{strobe} = 4.5 V		$T_A = MAX$			5			10	μA
I _{SL}	Low-level strobe current	V _{CC} = MAX, V _{strobe} = 0.4 V	V _{ID} = 0.5 V,	T _A = 25°C		-1.15	-2.4		-1.15	-2.4	mA
I(RTC)	Response-time- control current	$V_{CC} = MAX,$ $V_{RC} = 0$	$V_{ID} = 0.5 V,$	T _A = 25°C	-1.2	-3.4		-1.2	-3.4		mA
		V _{CC} = MIN,	V _{OH} = 12 V,	T _A = 25°C			100				
le (off)	Off-state open-collector	$V_{ID} = -4.5 V$		$T_A = MAX$			200				μA
IO(off)	output current	V _{CC} = MIN,	V _{OH} = 5.25 V,	T _A = 25°C						100	μΑ
	1	V _{ID} = -4.75 V	-	$T_A = MAX$						200	
RT	Line-terminating resistance	$V_{CC} = 5 V$		$T_A = 25^{\circ}C$	77	130	167	74	130	179	Ω
IOS	Supply-circuit output current#	$V_{CC} = MAX,$ $V_{O} = 0$	$V_{ID} = -0.5 V,$	T _A = 25°C	-15	-40	-80	-14	-40	-100	mA
ICC	Supply current (both receivers)	V _{CC} = MAX, V _{IC} = 0	$V_{ID} = 0.5 V,$	T _A = 25°C		32	50		32	50	mA

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

[†] Unless otherwise noted, V_{strobe} = 2.4 V. All parameters with the exception of off-state open-collector output current are measured with the active pullup connected to the sink output.

[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C, and V_{IC} = 0.

§ Differential voltages are at the B input terminal with respect to the A input terminal.

The algebraic convention, in which the less positive (more negative) limit is designated as minimum, is used in this data sheet for threshold voltages only.

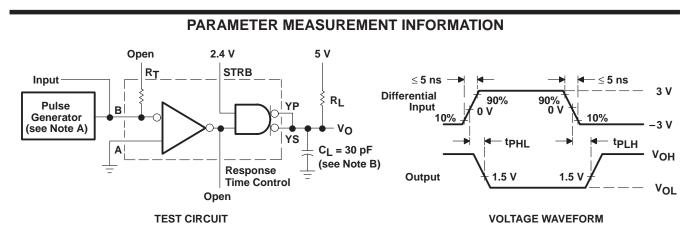
[#]Only one output should be shorted to ground at a time, and duration of the short circuit should not exceed one second.

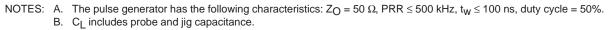


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switching characteristics, V_{CC} = 5 V, C_L = 30 pF, T_A = 25°C

PARAMETER		TEST CO	SN55115			SN75115			UNIT	
	FARAMETER	1231 00	MIN	TYP	MAX	MIN	TYP	MAX	UNIT	
^t PLH	Propagation delay time, low-to-high level output	R _L = 3.9 kΩ,	See Figure 1		18	50		18	75	ns
^t PHL	Propagation delay time, high-to-low level output	RL = 390 Ω,	See Figure 1		20	50		20	75	ns

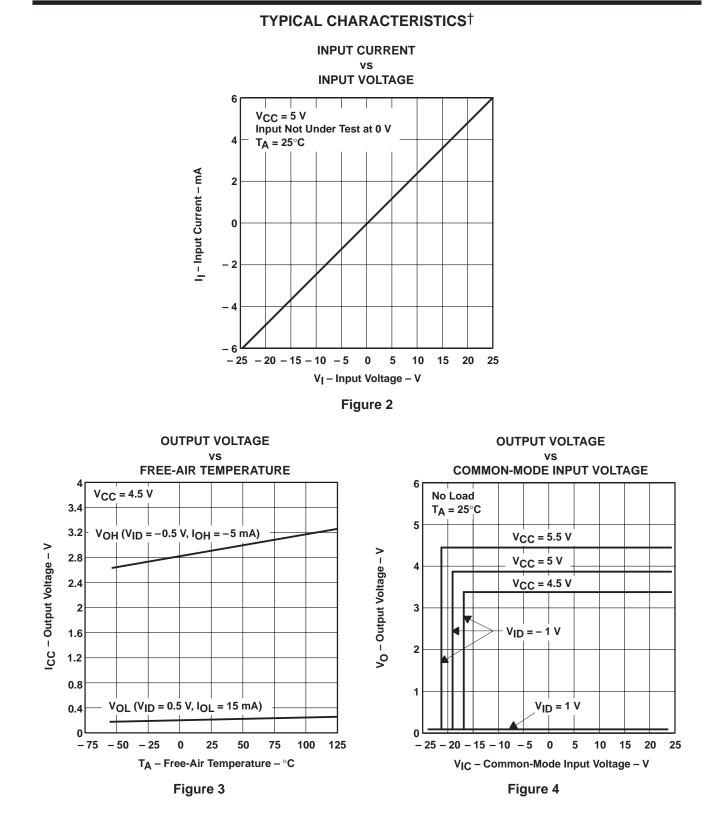








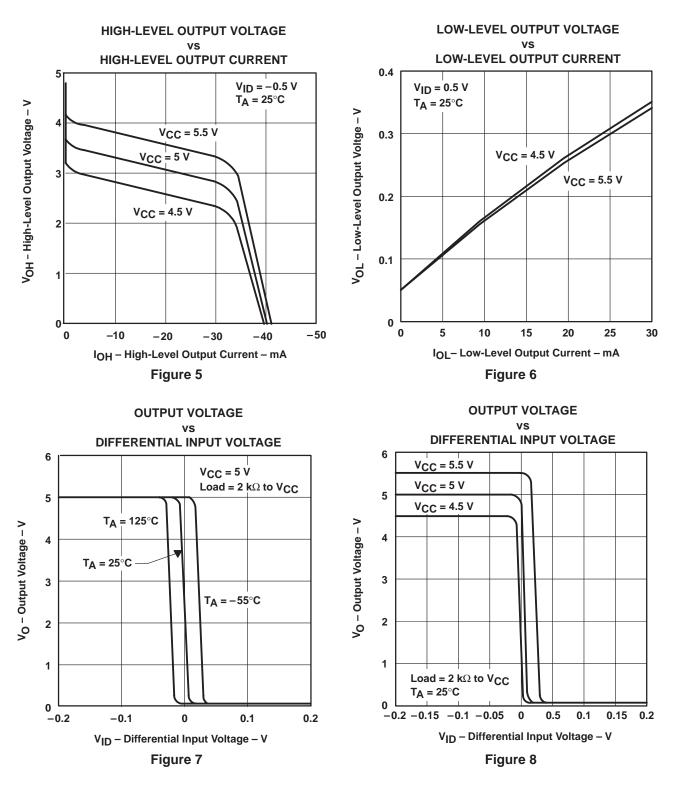
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⁺ Data for temperatures below 0°C and above 70°C and for supply voltages below 4.75 V and above 5.25 V are applicable to SN55115 circuits only. These parameters were measured with the active pullup connected to the sink output.

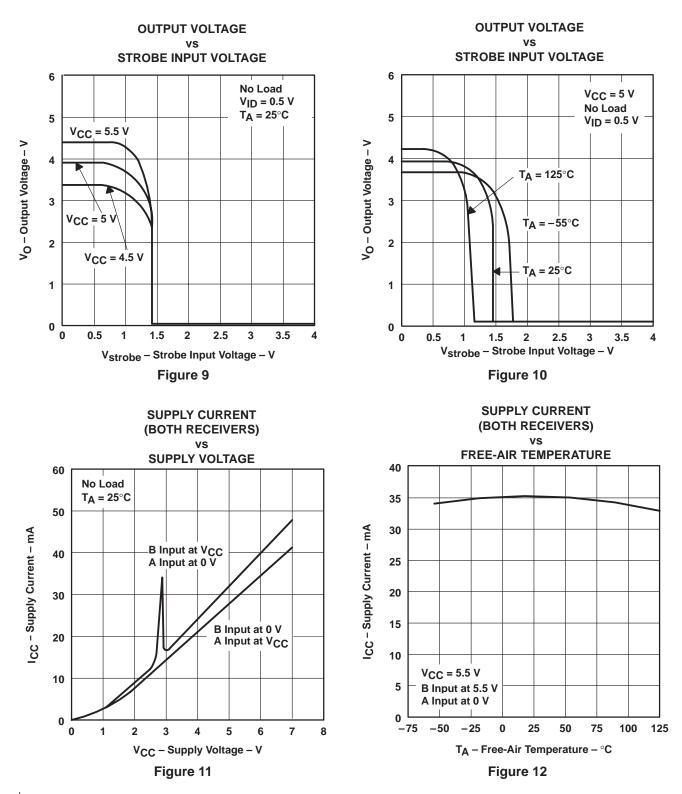


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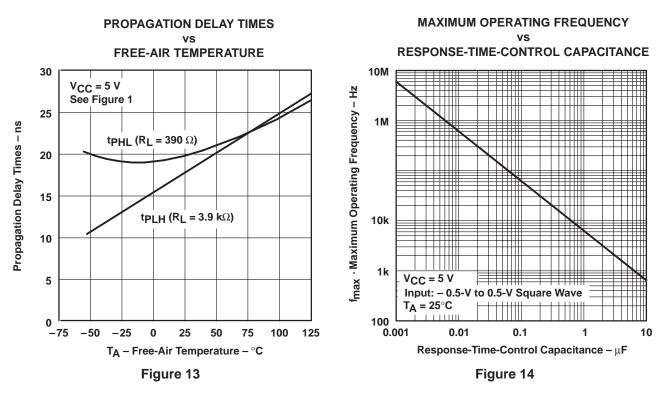
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TYPICAL CHARACTERISTICS[†]

[†] Data for temperatures below 0°C and above 70°C and for supply voltages below 4.75 V and above 5.25 V are applicable to SN55115 circuits only. These parameters were measured with the active pullup connected to the sink output.

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TYPICAL CHARACTERISTICS[†]

[†] Data for temperatures below 0°C and above 70°C and for supply voltages below 4.75 V and above 5.25 V are applicable to SN55115 circuits only. These parameters were measured with the active pullup connected to the sink output.

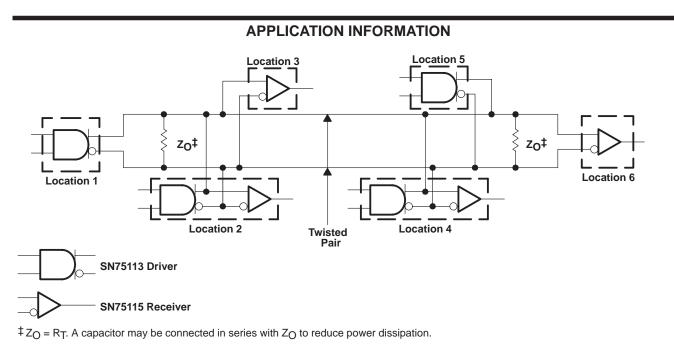


Figure 15. Basic Party-Line or Data-Bus Differential Data Transmission





PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-88745012A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962- 88745012A SNJ55 115FK	Samples
5962-8874501FA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8874501FA SNJ55115W	Samples
JM38510/10404BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510 /10404BEA	Samples
M38510/10404BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510 /10404BEA	Samples
SN55115J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN55115J	Samples
SN75115D	LIFEBUY	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75115	
SN75115DR	LIFEBUY	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75115	
SN75115N	LIFEBUY	PDIP	Ν	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN75115N	
SN75115N-A	LIFEBUY	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type		SN75115N-A	
SN75115NE4	LIFEBUY	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN75115N	
SN75115NSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75115	Samples
SNJ55115FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962- 88745012A SNJ55 115FK	Samples
SNJ55115J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ55115J	Samples
SNJ55115W	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8874501FA SNJ55115W	Samples

⁽¹⁾ The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. **PREVIEW:** Device has been announced but is not in production. Samples may or may not be available. **OBSOLETE:** TI has discontinued the production of the device.



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⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN55115, SN75115 :

• Catalog : SN75115

• Military : SN55115

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications



Texas

STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*Al	dimensions are nominal												
Γ	Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
	SN75115DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
	SN75115NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



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PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN75115DR	SOIC	D	16	2500	340.5	336.1	32.0
SN75115NSR	SO	NS	16	2000	356.0	356.0	35.0

TEXAS INSTRUMENTS

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TUBE



- B - Alignment groove width

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
5962-88745012A	FK	LCCC	20	1	506.98	12.06	2030	NA
5962-8874501FA	W	CFP	16	1	506.98	26.16	6220	NA
SN75115D	D	SOIC	16	40	507	8	3940	4.32
SN75115N	N	PDIP	16	25	506	13.97	11230	4.32
SN75115NE4	N	PDIP	16	25	506	13.97	11230	4.32
SNJ55115FK	FK	LCCC	20	1	506.98	12.06	2030	NA
SNJ55115W	W	CFP	16	1	506.98	26.16	6220	NA

NS0016A



PACKAGE OUTLINE

SOP - 2.00 mm max height

SOP



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing
- Per ASME Y14.5M.
 This drawing is subject to change without notice.
 This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



NS0016A

EXAMPLE BOARD LAYOUT

SOP - 2.00 mm max height

SOP



NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



NS0016A

EXAMPLE STENCIL DESIGN

SOP - 2.00 mm max height

SOP



NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

8. Board assembly site may have different recommendations for stencil design.



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP2-F16



FK 20

8.89 x 8.89, 1.27 mm pitch

GENERIC PACKAGE VIEW

LCCC - 2.03 mm max height

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



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